

12-28-2000

Form 1595  
1-31-92

RECORD

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U.S. Department of Commerce  
Patent and Trademark Office

To the Honorable Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):  
  
Horng-Huei Tseng

2. Name/address of receiving Party(ies):  
  
Vanguard International  
Semiconductor Corp.  
123, Park Ave-3rd, Science-Based  
Industrial Park, Hsinchu, Taiwan, R.O.C.

3. Nature of conveyance:  Assignment  
 Merger  Security Agreement  Other  
 Change of Name  Reassignment

4. Date(s) of execution: November 25, 2000.

Add'l names of receiving parties  
Attached?  Yes  No

5. Application number(s) or patent number(s):  
**If this documents is being filed together with a new application, the execution date of the application is November 25, 2000.**

A. Patent Application No. (s)  
  
Additional numbers attached ?

B. Patent No. (s) 9/1734287  
 Yes  No

6. Name and address of party to whom Correspondence concerning document should be mailed:  
  
J.C. Patents, Inc.  
7700 IRVINE CENTER DRIVE, SUITE 710  
IRVINE, CALIFORNIA 92618-3043  
(949) 251-0111

7. Total No. of applications and patents involved:  
  
ONE(1)

8. Total fee (37 CFR §3.41): \$40.00  
 Enclosed  
 Charge to Acct. No. \_\_\_\_\_

9. Total number of pages, including Cover sheet, attachments and document 3.

DO NOT USE THIS SPACE

10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jiawei Huang  
Name of Person Signing

Jiawei Huang  
Signature

12/11/2000  
Date

Registration No. 43,330

12/27/2000 GTON11 00000135 09734287

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JC760 U.S. PTO  
09/734287  
12/11/00

# ASSIGNMENT

WHEREAS,

1. Horng-Huei Tseng

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD FOR FABRICATING TRANSISTOR

- Filed: Serial No.
- Executed concurrently with the execution of this instrument

WHEREAS, Vanguard International Semiconductor Corp.  
of 123, Park Ave-3rd, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

# ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Horng-Huei Tseng

Signature:

Sole or First Joint Inventor: Horng-Huei Tseng

Date: NOV. 25, 2000